

LM4831 Boomer® Audio Power Amplifier Series Multimedia Computer Audio Chip

General Description

The LM4831 is a monolithic integrated circuit that provides a stereo three input mixer, two stereo input analog multiplexer, a stereo line out and a dual 1W bridged audio power amplifier. In addition, a low noise microphone preamp is included on-chip.

The LM4831 is ideal for multimedia computers since it incorporates an input mixer, analog multiplexer, and configurable stereo audio power amplifier, as well as a microphone preamp stage. This combination allows for all of the analog audio processing to be enclosed in a 44-pin TQFP package.

The LM4831 features an externally controlled, low-power consumption shutdown mode, as well as both headphone and docking station modes. To temporarily override the shutdown mode and allow audio signals to be amplified, the LM4831 provides four "beep" pins.

Key Specifications

■ THD+N at 1W into 8Ω	0.6% (typ)
■ Microphone Input Referred Noise	10μV (typ)
■ Supply Current - Bridged Mode	16mA (typ)
■ Shutdown Current	2μA (typ)

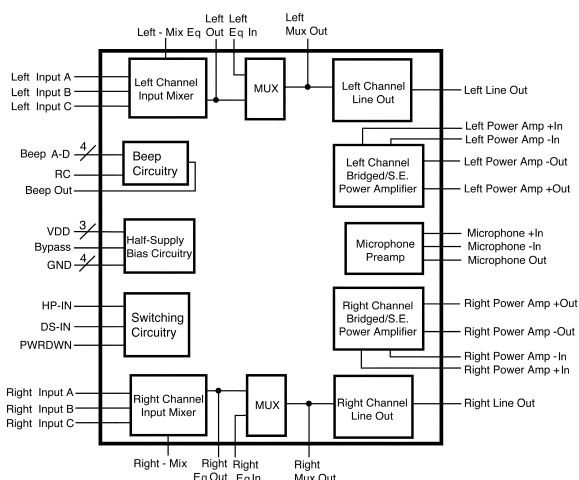
Features

- Stereo 1W audio power amplifier
- "Click and pop" suppression circuitry
- Stereo three input mixer
- Shutdown mode
- Multiple operating modes—bridged, single-ended and docking station modes
- Internal mux for switching in/out external filter
- Beep circuitry for "wake-up" while in shutdown
- 44 Pin TQFP Packaging

Applications

- Portable and Desktop Computers

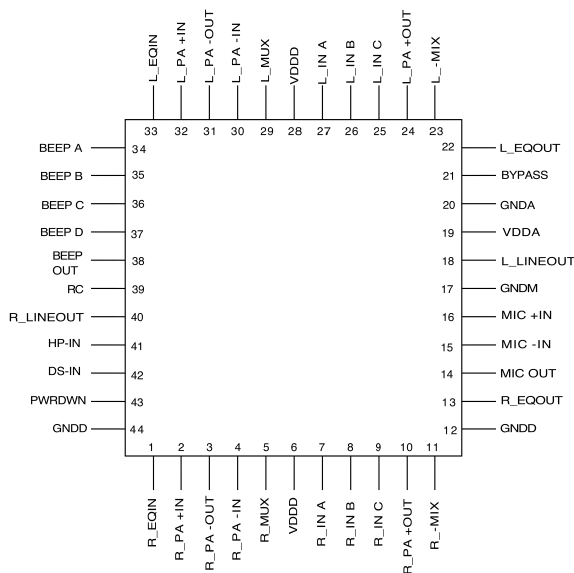
Block Diagram



DS100057-1

FIGURE 1. LM4831 Block Diagram

Connection Diagram



DS100057-3

Top View
Order Number LM4831VF
See NS Package Number VEJ44A

Absolute Maximum Ratings (Note 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage	6.0V
Storage Temperature	-65°C to 150°C
Input Voltage	-0.3V to $V_{DD} + 0.3V$
Power Dissipation (Note 3)	Internally limited
ESD Susceptibility (Note 4)	2500V
ESD Susceptibility (Note 5)	200V
Junction Temperature	150°C
Soldering Information	
Small Outline Package	

Vapor Phase (60 sec.) 215°C

Infrared (15 sec.) 220°C

See AN-450 "Surface Mounting and their Effects on Product Reliability" for other methods of soldering surface mount devices.

Thermal Resistance	
θ_{JC} (typ)	15°C/W
θ_{JA} (typ)	62°C/W

Operating Ratings

Temperature Range	-40°C to 85°C
Supply Voltage	$2.7 \leq V_{DD} \leq 5.5V$

Electrical Characteristics

(Notes 1, 2) The following specifications apply for $V_{DD} = 5V$, $R_L = 8\Omega$ and $f = 1\text{ kHz}$, unless otherwise specified. **Distortion measurements represent the full audio chain from Input A of each channel to their respective output.** Limits apply for $T_A = 25^\circ\text{C}$.

Symbol	Parameter	Conditions	LM4831		Units (Limits)
			Typical (Note 6)	Limit (Note 7)	
General Characteristics For Entire IC					
V _{DD}	Supply Voltage			2.7 5.5	V (min) V (max)
I _{DD}	Quiescent Power Supply Current	Bridged Mode, I _O = 0 mA Single-Ended Mode, I _O = 0 mA Docking Station Mode, I _O = 0 mA	16 10.5 7	50	mA (max) mA mA
I _{SD}	Shutdown Current	V _{PIN-43} = 5V, V _{PIN-41} = V _{PIN-42} = 0V	2	50	μA (max)
V _{DD/2}	Half Supply Bypass Voltage	V _{IN} = 0V, V _{PIN-43} = 0V	2.45	2.4 2.6	V (min) V (max)
Power Amplifiers					
P _O	Output Power - Bridged Mode	R _L = 8Ω, THD = 1% R _L = 4Ω, THD = 1%	1.1 1.5	1	W (min) W
	Output Power - Single-Ended Mode	R _L = 8Ω, THD = 1% R _L = 4Ω, THD = 1%	300 550		mW mW
THD	Total Harmonic Distortion	Bridged Mode, P _O = 1W, R _L = 8Ω Single-Ended Mode, P _O = 225mW, R _L = 8Ω	0.5 0.15	2.0	% (Max) %
V _{OS}	Output Offset Voltage	V _{IN} = 0V	5	50	mV (Max)
E _{Noise}	Input Referred Noise	A-Weighted Filter, V _{IN} = 0V, R _L = 8Ω Bridged Output Single-Ended Output	45 35	100 100	μV (max) μV (max)
PSRR	Power Supply Rejection Ratio	f = 1kHz, C _B = 0.5μF, R _L = 8Ω Bridged Output Single-Ended Output	47 45		dB dB
X _{TALK}	Channel to Channel Crosstalk	f = 1kHz, P _O = 1W, R _L = 8Ω Right to Left Left to Right	-82 -73		dB dB
I _{TS}	TRI-STATE® Current-Single Ended Mode	V _{PIN-41} = 4.0V, L _{PA+OUT} = R _{PA+OUT} = V _{DD} or GND	80	100	μA (max)

Electrical Characteristics (Continued)

(Notes 1, 2) The following specifications apply for $V_{DD} = 5V$, $R_L = 8\Omega$ and $f = 1\text{ kHz}$, unless otherwise specified. **Distortion measurements represent the full audio chain from Input A of each channel to their respective output.** Limits apply for $T_A = 25^\circ\text{C}$.

Symbol	Parameter	Conditions	LM4831		Units (Limits)
			Typical (Note 6)	Limit (Note 7)	
Microphone Amplifier					
THD	Total Harmonic Distortion	R _L = 10 kΩ, V _{IN} = 1 V _{RMS}	0.15		%
E _{Noise}	Input Referred Noise	A--weighted Filter	10	18	μV (max)
X _{TALK}	Crosstalk	Amplifier Bridged Output, f = 1kHz, P _O = 1W, R _{L-mic} = 20kΩ	95		dB
Other Audio Characteristics					
THD	Total Harmonic Distortion	R _L = 20 kΩ, V _{IN} = 1 V _{RMS}			
		Line Out	0.15	0.5	% (max)
		Equalizer Out	0.01		%
E _{Noise}	Input Referred Noise	A-weighted filter, Line Out	20	100	μV (max)
A _V	Channel Path Gain	Line Out	±0.1	±0.7	dB (max)
		Equalizer Out	±0.1	±0.6	dB (max)
		MUX Out	−0.25	−0.85, +0.3	dB
E _T	Stereo Tracking Error	Line Out	±0.1	±0.5	dB (max)
Digital Inputs and Outputs					
V _{IL}	Input Low Voltage			1.0	V (max)
V _{IH}	Input High Voltage			4.0	V (min)
V _{OL}	Output Low Voltage			0.5	V (max)
V _{OH}	Output High Voltage			3.5	V (min)

Note 1: All voltages are measured with respect to the ground pins, 12, 17, 20, and 44, unless otherwise specified.

Note 2: *Absolute Maximum Ratings* indicate limits beyond which damage to the device may occur. *Operating Ratings* indicate conditions for which the device is functional, but do not guarantee specific performance limits. *Electrical Characteristics* state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

Note 3: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX} , θ_{JA} , and the ambient temperature T_A . The maximum allowable power dissipation is $P_{DMAX} = (T_{JMAX} - T_A)/\theta_{JA}$. For the LM4831, $T_{JMAX} = 150^\circ\text{C}$, and the typical junction-to-ambient thermal resistance, when board mounted, is 62°C/W assuming the VEF44A package.

Note 4: Human body model, 100 pF discharged through a 1.5 k Ω resistor.

Note 5: Machine Model, 220 pF–240 pF discharged through all pins.

Note 6: Typicals are measured at 25°C and represent the parametric norm.

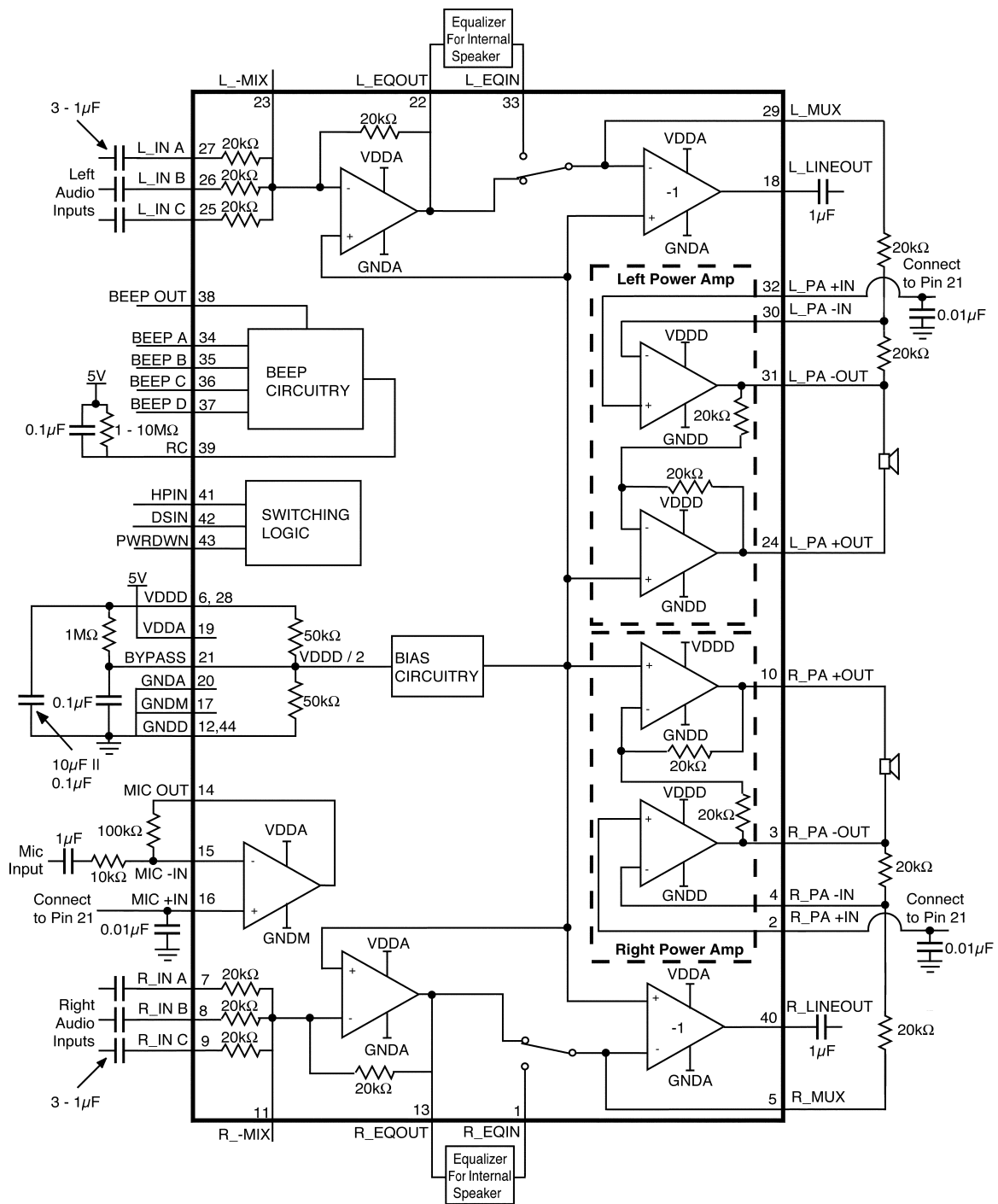
Note 7: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

Digital Inputs Pin Truth Table

Pin Name			LM4831 State
PWRDWN	HPIN	DSIN	
0	0	0	Bridged Outputs Active Equalizer In/Out Active
0	0	1	Line-Outs Active
0	1	X(Note 8)	Single-Ended Outputs Active
1	X	X	Shutdown

Note 8: "X" means that the state of that pin does not matter in that particular input combination.

Typical Application



DS100057-2

FIGURE 3. Typical Application Circuit

Pin Descriptions

VDDA	This is the analog power supply pin which powers all internal circuitry, with the exceptions of the output amplifiers and the digital logic in the Beep and Switching circuit sections. This pin should be connected to the same supply voltage as the two VDDD pins (typically 5V), but have a separate ground return path to the supply ground to minimize interaction with the high current amplifier returns and digital switching noise. In addition, this pin should be bypassed with a 0.01 μ F–0.1 μ F capacitor.	BYPASS	This voltage at this pin is nominally 1/2 VDDD and is created by an internal 50 k Ω resistor divider. This node should be bypassed with a capacitor value from 0.1 μ F–1.0 μ F. Increasing the capacitor value will increase the ramp time of the amplifiers, thereby improving turn-on pop performance. 0.1 μ F is typical for the bypass capacitor. In addition, a 1 M Ω resistor from the bypass pin to the positive supply is shown in <i>Figure 3</i> . This resistor guarantees that the LM4831 will turn-on if the device is powered up with both the PWRDWN and DS-IN pins high. If the LM4831 will never enter that state, then the 1M Ω resistor can be removed.
VDDD	These pins are the “digital” and high current power supply pins which power the stereo bridged output amplifier and the digital logic in the Beep and Switching circuit sections. These pins should be connected to the same supply voltage as the VDDA pin (typically 5V), but have a separate return path to the supply to avoid interfering with low level signals. In addition, this pin should be bypassed with a 0.01 μ F–0.1 μ F capacitor. At the power supply connection, a bulk storage capacitor of at least 10 μ F will reduce the instantaneous current demanded from the power supply.	HP-IN	This pin places the output power amplifier in “headphone” mode. If HP-IN is low, the amplifier is in bridged mode and the 2:1 mux passes the input on the EQ_IN pin. If HP-IN is high, the amplifier is in single-ended mode and the 2:1 mux passes the output of the mixing stage. Single-ended mode places the non-inverting amplifier in the output amplifiers into a high impedance state. HP-IN also has priority over the DS-IN pin, so if HP-IN and DS-IN are both high, the device is in single-ended mode and the stereo line out amplifier is in a high-impedance state.
GNDA, GNDD, GNDM	These are the power supply ground pins. GNDA is the ground pin for the low current analog circuitry. The two GNDD pins are for the digital logic and bridged output amplifiers. GNDM is the ground for the microphone amplifier. Make sure that the high current GNDD paths are not returned through the low current GNDA or GNDA paths. These four ground pins should be star-grounded at a stable, low-impedance, noise-free system ground.	DS-IN	This pin is used to put the LM4831 into “docking-station” mode and control the line out drivers and the state of the internal 2:1 analog multiplexer. If DS-IN is high, the stereo line out amplifier is on and the stereo bridged amplifier is in a high impedance state. Asserting the DS-IN pin also changes the 2:1 analog multiplexer output from the stereo signal on the L_EQIN and R_EQIN pins to the internal path from the stereo input mixer.

Pin Descriptions (Continued)

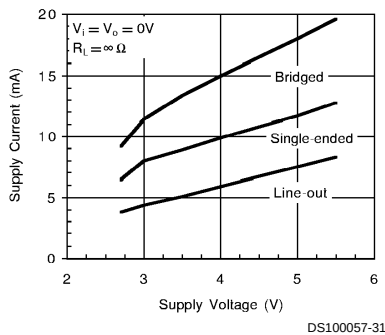
PWRDWN	This pin is used to power down the entire IC (except BEEP Circuitry). Placing a logic high on the PWRDWN pin will place the LM4831 in a low supply current state. To minimize the shutdown-mode supply current, the PWRDWN pin should be pulled up to the voltage on the LM4831 power supply pins. The PWRDWN pin is overridden if an edge change occurs on any of the BEEP A–D inputs.	L_LINEOUT, R_LINEOUT	These are the line outputs for the left and right channel, respectively. Although these outputs are capable of driving a wide range of resistive loads, they are typically used to drive an impedance of at least 10 k Ω . These outputs are only enabled when the DS-IN pin is high, otherwise, they are in a high-impedance state.
L_INA, L_INB, L_INC	These pins are the left channel inputs. Typical input impedance on each input is 20 k Ω .	L_PA+IN, R_PA+IN	These pins are the positive inputs of the output audio power amplifiers. Since the power amplifier is typically configured as an inverting amplifier, these pins should be connected to the BYPASS pin to properly bias the output power amplifiers. Further, these pins should be individually bypassed with a capacitor of 0.01 μ F–0.1 μ F.
R_INA, R_INB, R_INC	These pins are the right channel inputs. Typical input impedance on each input is 20 k Ω .	L_PA–IN, R_PA–IN	These pins are the inverting inputs for the output audio power amplifier for the left and right channel, respectively.
L_MIX, R_MIX	These pins are the inverting input nodes of the input mixer for the left and right channel, respectively.	L_PA–OUT, R_PA–OUT	These pins are the inverted power amp outputs for the left and right channel, respectively. In bridged mode (DS-IN = HP_IN = PWRDWN = low), each output drives one terminal of a direct coupled bridged speaker. In single-ended (headphone) mode, (HP_IN = high, PWRDWN = low, DS-IN = N/A) these outputs drive a capacitively coupled stereo headphone. In docking station mode (DS-IN = high, HP_IN = PWRDWN = low), these outputs are disabled.
L_EQOUT, R_EQOUT	These are the outputs of the input mixer for the left and right channel, respectively. This output is generally fed to an external filter to equalize the response of internal computer speakers and then back into the EQIN pins.	L_PA+OUT, R_PA+OUT	These pins are the non-inverted power amp outputs for the left and right channel, respectively. In bridged mode (DS-IN = HP_IN = PWRDWN = low), each output drives one terminal of a direct coupled bridged speaker. In single-ended (headphone) mode (HP_IN = high, PWRDWN = low, DS-IN = N/A), these outputs are in a high impedance state, effectively muting the bridged loudspeaker. In docking station mode (DS-IN = high, HP_IN = PWRDWN = low), these outputs are disabled.
L_EQIN, R_EQIN	These pins are one of the two inputs to the 2:1 analog multiplexer and are used to feed in externally filtered versions of the EQOUT signals. The 2:1 multiplexer selects the signal on L_EQIN and R_EQIN if the HP_IN and DS_IN pins are both low.		
L_MUX, R_MUX	These are the stereo outputs of the 2:1 analog multiplexer. The output of the 2:1 multiplexer is decided by the state of the HP-IN and DS-IN pins. If both HP-IN and DS-IN are low, the 2:1 mux selects the analog input on the EQIN pins. If either HP-IN or DS-IN is high, the 2:1 mux selects the internal analog path. See .		

Pin Descriptions (Continued)

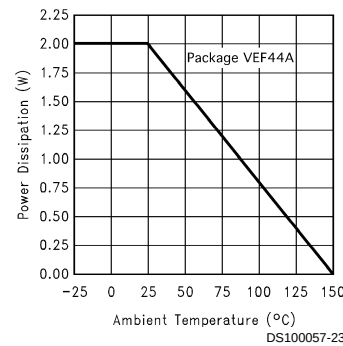
MIC+IN	This pin is the positive input of the microphone amplifier. The microphone amplifier is typically configured as an inverting amplifier, so this pin should be connected to the BYPASS pin to properly bias the amplifier. Further, this pin should be individually bypassed with a capacitor of $0.01\mu\text{F}$ – $0.1\mu\text{F}$.	BEEP A, BEEP B, BEEP C, BEEP D	These four pins are used to “wake up” the LM4831 for a specified amount of time (dictated by the parallel resistor and capacitor connected to the RC pin). If the device is in shutdown and an edge appears at any of the four BEEP pins, then the device will power-up, pass the sound, and then power-down again.
MIC-IN	This pin is the inverting input for the microphone amplifier. Because the microphone amplifier is typically used as an inverting amplifier, this pin should be capacitor coupled to the input signal.	BEEP OUT	This pin outputs the result of an exclusive-or of the four BEEP inputs. BEEP OUT connects back to the Audio Codec as a status pin.
MIC OUT	This pin is the microphone amplifier output. If this pin is to be connected to any chips other than the LM4831, it should be capacitor coupled to the load.	RC	This pin is connected to an external resistor-capacitor network which sets the on-time for a beep request. Typically, a $0.1\mu\text{F}$ capacitor is paralleled with a $1\text{--}10\text{M}\Omega$ resistor.

Typical Performance Characteristic

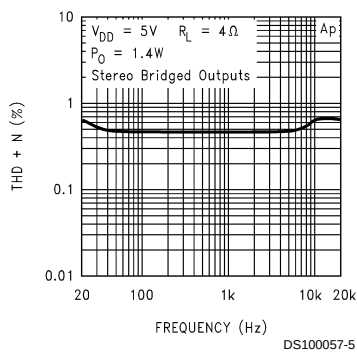
Supply Current vs
Supply Voltage



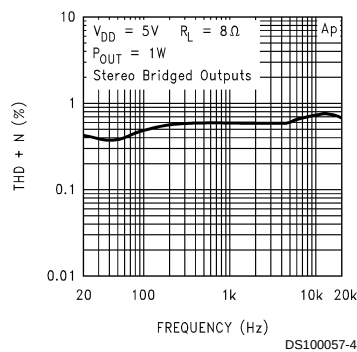
Power Derating Curve



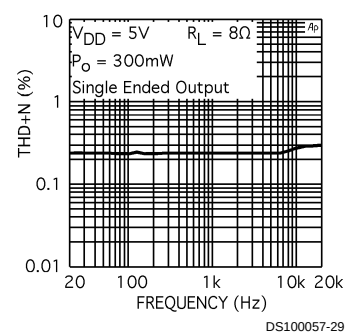
THD+N vs Frequency



THD+N vs Frequency

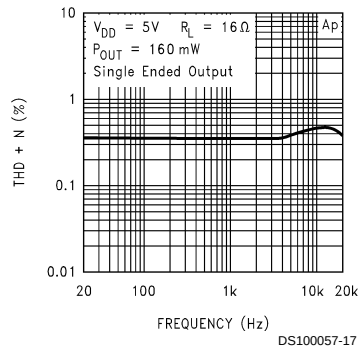


THD+N vs Frequency

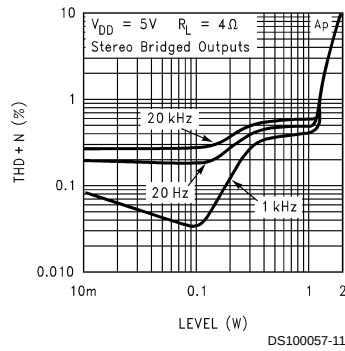


Typical Performance Characteristic (Continued)

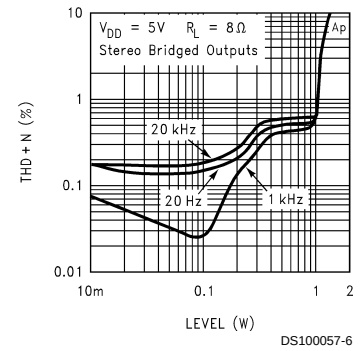
THD+N vs Frequency



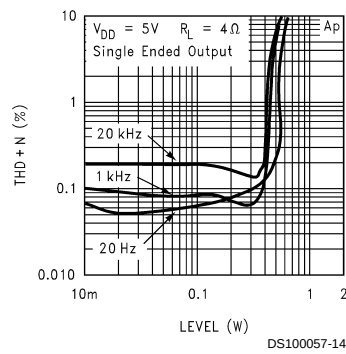
THD+N vs Output Power



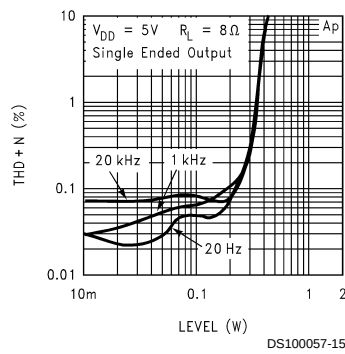
THD+N vs Output Power



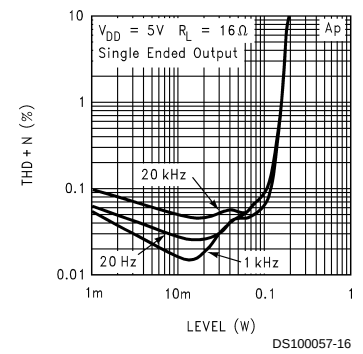
THD+N vs Output Power



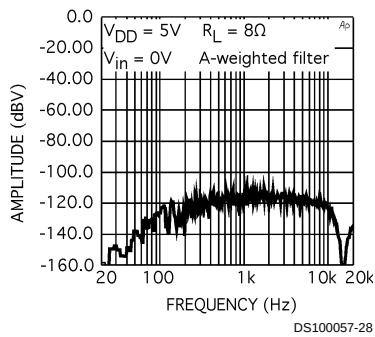
THD+N vs Output Power



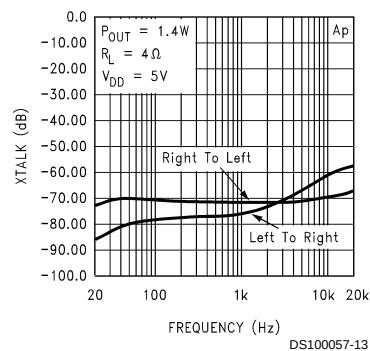
THD+N vs Output Power



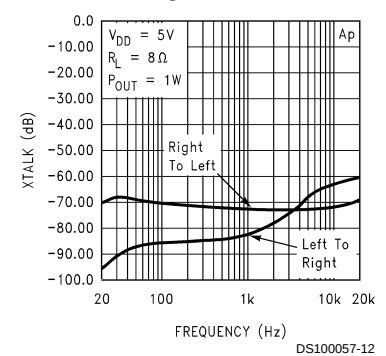
Power Amplifier Noise Floor



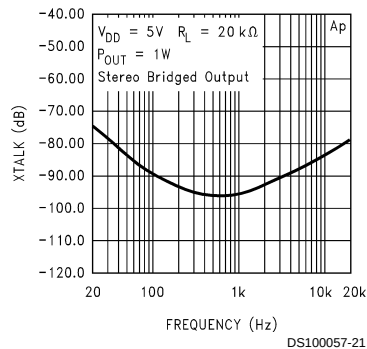
Power Amplifier Crosstalk, Bridged



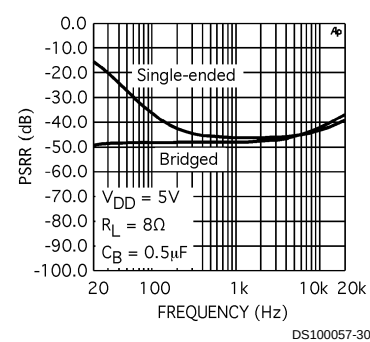
Power Amplifier Crosstalk, Bridged



Power Amplifier Crosstalk to Mic

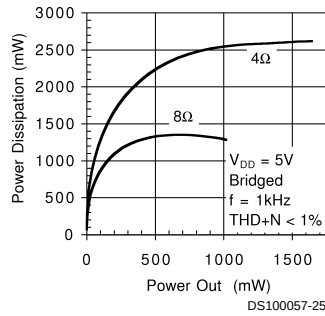


Power Amplifier PSRR

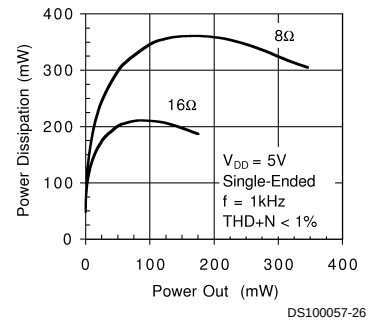


Typical Performance Characteristic (Continued)

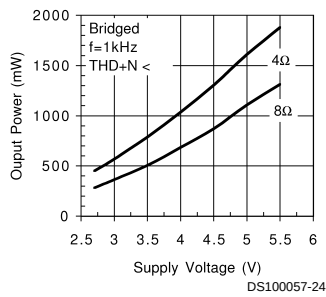
Power Dissipation, Bridged



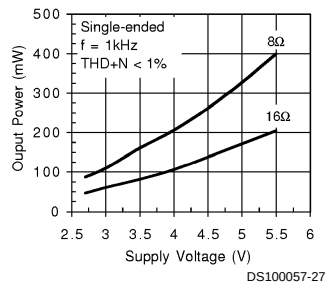
Power Dissipation, Single-Ended



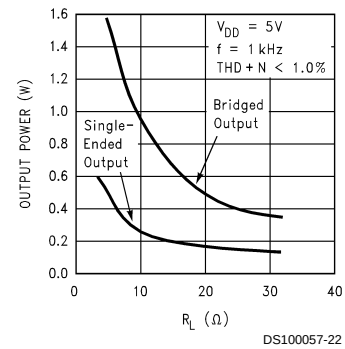
Output Power vs Supply Voltage Bridged



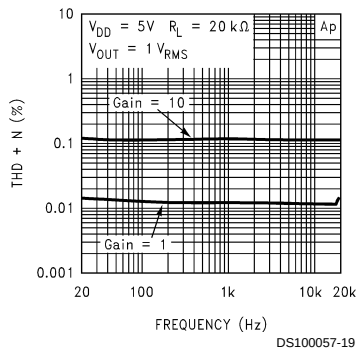
Output Power vs Supply Voltage Single-Ended



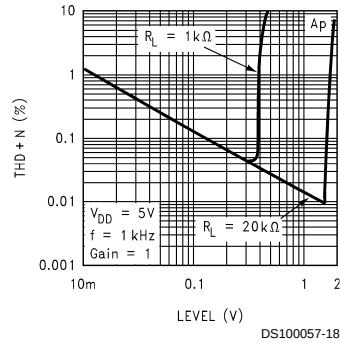
Output Power vs Load



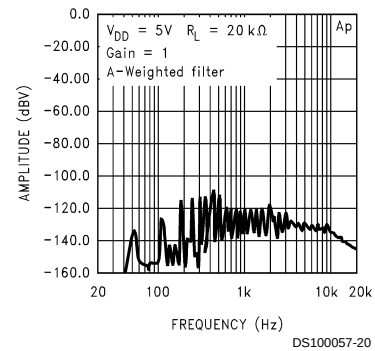
Microphone THD+N vs Frequency



Microphone THD+N vs Output Level

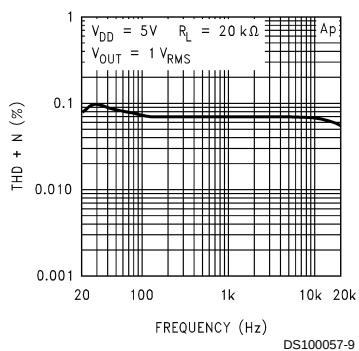


Microphone Noise Floor

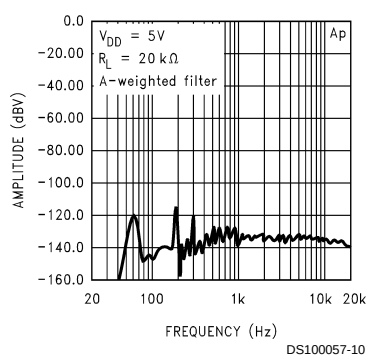


Typical Performance Characteristic (Continued)

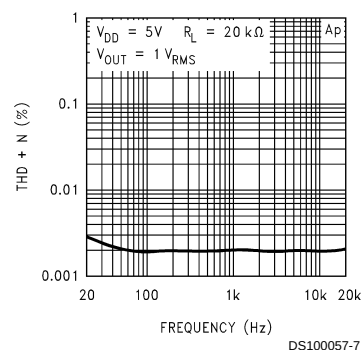
**Line Out
THD+N vs Frequency**



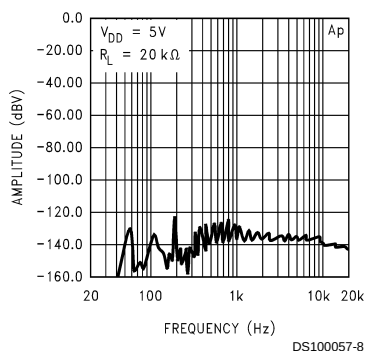
**Line Out
Noise Floor**



**Equalizer Output
THD+N vs Frequency**



**Equalizer Output
Noise Floor**



Application Information

GROUNDING

Certain grounding techniques should be followed when laying out the LM4831 circuit. Figure 4 shows how to setup the grounds for the LM4831. The half-supply bypass ground

should be tied with the input source grounds and brought back to the power supply ground separately from the output load grounds. Bringing the output load grounds back to the supply separately will keep large signal currents from interfering with the stable input ground references.

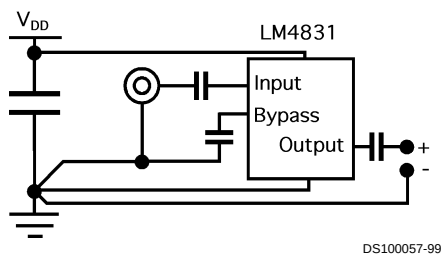


FIGURE 4. Grounding Strategy for LM4831

LAYOUT

As stated in the Grounding section, placement of ground return lines is critical for maintaining the highest level of system performance. It is not only important to route the correct ground return lines together, but also important to be aware of where those ground return lines are routed relative to each other. The output load ground returns should be physically located as far as reasonably possible from low signal

level lines and their ground return lines. The layout of the microphone amplifier signal lines is critical, since these lines generally work at very low signal levels.

SUPPLY BYPASSING

As with all op amps and power op amps, the LM4831 requires the power supplies to be bypassed to reduce distortion and avoid oscillation. To avoid high frequency instabilities, a 0.1 μF metallized-film or ceramic capacitor should be used to bypass each supply pin as near to the chip as pos-

Application Information (Continued)

sible. For low frequency considerations, a 10 μ F or greater tantalum or electrolytic capacitor should be paralleled with the high frequency bypass capacitor.

If power supply bypass capacitors are not sufficiently large, the current in the power supply leads, which is a rectified version of the output current, may be fed back into internal circuitry. This internal feedback signal can cause high frequency distortion and oscillation.

If power supply lines to the chip are long, larger bypass capacitors could be required. Long power supply leads have inductance and resistance associated with them, which could prevent peak low frequency current demands from being met. The extra bypass capacitance will reduce the peak current requirements from the power supply lines.

Under certain conditions, the LM4831 may refuse to come out of shutdown. A 1M Ω resistor connected from the power supply to the bypass pin, as shown in the **Typical Application** section circuit, *Figure 3*, will guarantee startup.

CLICK & POP CIRCUITRY AND THE BYPASS CAPACITOR

The LM4831 contains circuitry to minimize turn-on transients. In this case, turn-on refers to either power supply turn-on or the device coming out of shutdown mode. During turn-on, an internal current source charges the bypass capacitor on the bypass pin. Both the inputs and outputs track the voltage at the bypass pin. As soon as the bypass node is stable at $1/2 V_{DD}$, the amplifier will become fully operational.

Although the bypass pin current source cannot be modified, the size of the bypass capacitor, C_b , can be changed to alter the device turn-on time and the amount of "click and pop". The relationship between the size of C_b and the turn-on time is linear. By increasing C_b , the amount of turn-on pop can be reduced. However, the trade-off for using a larger bypass capacitor is an increase in the turn-on time for the device. Reducing C_b will decrease turn-on time and increase "click and pop". If C_b is too small, the LM4831 can develop a low-frequency oscillation ("motorboat") when used at high gains.

In order to eliminate "click and pop", all coupling capacitors must be discharged before turn-on. Rapid on/off switching of the device or shutdown function may cause the "click and pop" circuitry to not operate fully, resulting in increased "click and pop" noise. For single-ended (headphone) circuitry, the output coupling cap, C_o , is of particular concern. In shutdown, this capacitor is discharged through an internal 20k Ω resistor. Depending on the size of C_o , the discharging time constant can be quite large. To reduce the time constant, an external 1k Ω -5k Ω resistor can be placed in parallel with the internal 20k Ω resistor. The tradeoff for using this resistor is an increase in quiescent current and an increase in turn-off "click and pop".

Changing the bypass capacitor size also affects the amount of time that the beep circuitry turns on the LM4831. Increasing the bypass capacitor size increases the turn-on time, which reduces the amount of time that the LM4831 is fully on for during the RC-timed beep period.

The bypass capacitor also helps determine the power supply rejection ratio. The smaller the bypass capacitor, the more the power supply ripples couple onto the half supply and then to all circuitry which uses the half supply for biasing.

COUPLING CAPACITORS

Since the LM4831 is a single supply circuit, all audio signals (excepting the bridged outputs) must be capacitor coupled to the chip to remove the 2.5V_{DC} bias. All audio inputs have a 20k Ω input impedance, so the AC-coupling capacitor will create a high-pass filter with $f_{-3dB} = 1/(2\pi \cdot 20k\Omega \cdot C_{in})$. For a -3dB point at 20Hz, C_{in} should be 0.39 μ F.

Single-ended and line-out loads need to be AC-coupled back to the LM4831 amplifiers. This high-pass filter is comprised of the output load and the coupling capacitor, where the filter cutoff is at $f_{-3dB} = 1/(2\pi \cdot R_{load} \cdot C_{out})$. If $R_L = 8\Omega$, then for a -3dB point at 20Hz, C_{out} should be 1000 μ F.

EQUALIZER INPUT/OUTPUT

In some systems, the internal speakers require filtering to improve their frequency response. The LM4831 provides the system designer with external access to the signal using the equalizer output and equalizer inputpins. When the DS_IN and HP_IN pins are low (ie. the system is not in the docking station and no headphone are plugged in), an internal mux routes the audio signal to the equalizer output pin. After the signal is filtered, it is returned to the LM4831 audio path through the equalizer inputpin.

The input impedance to the equalizer input pin is 20k Ω . If the external filter's bias voltage is not derived from the half supply pin on the LM4831, AC-coupling capacitors must be used on the equalizer input and output pins. If no equalization is required, the equalizer out pin can be connected directly to the equalizer in pin without any coupling capacitors.

LINE OUT

The line out pins are designed for use with a docking station system. When the computer is plugged into the docking station, the DS_IN pin should be forced high, thereby turning off the power amplifier outputs and turning on the line out amplifiers. All audio amplification and filtering is then done by the docking station. The line out pins must be AC-coupled to the docking station audio inputs.

POWER AMPLIFIERS

The power amplifiers in the LM4831 are designed to drive 8 Ω or 32 Ω loads at 1W (continuous) or 250mW(continuous), respectively, with 1% THD+N. If the power amplifiers are used to drive single-ended loads, such as headphones, the amplifier inverting outputs should be AC-coupled to the output load. When the LM4831 is in headphone (single-ended) mode, the amplifier non-inverting inputs are in a high-impedance state.

In low gain applications ($A_v < 5$), the LM4831 may require a small feedback capacitance to prevent oscillation. Typically, 5-10pF will prevent oscillation.

MICROPHONE AMPLIFIER

The microphone amplifier is an uncommitted op-amp which is intended to amplify low-level signals. The microphone inputs are very high impedance ($R_{in} > 1M\Omega$) and can be directly connected to microphone networks. The microphone amplifier has enough output capability to drive a 1k Ω load. All microphone inputs and outputs must be AC-coupled.

As shown in *Figure 1*, the microphone amplifier is typically configured as an inverting amplifier. The positive terminal is connected to the half-supply bypass pin to properly bias the amplifier output to interface with the other inputs on the

Application Information (Continued)

LM4831. The microphone input pin is connected to the inverting node of a CMOS op amp, so the input impedance is very high ($>10\text{M}\Omega$)

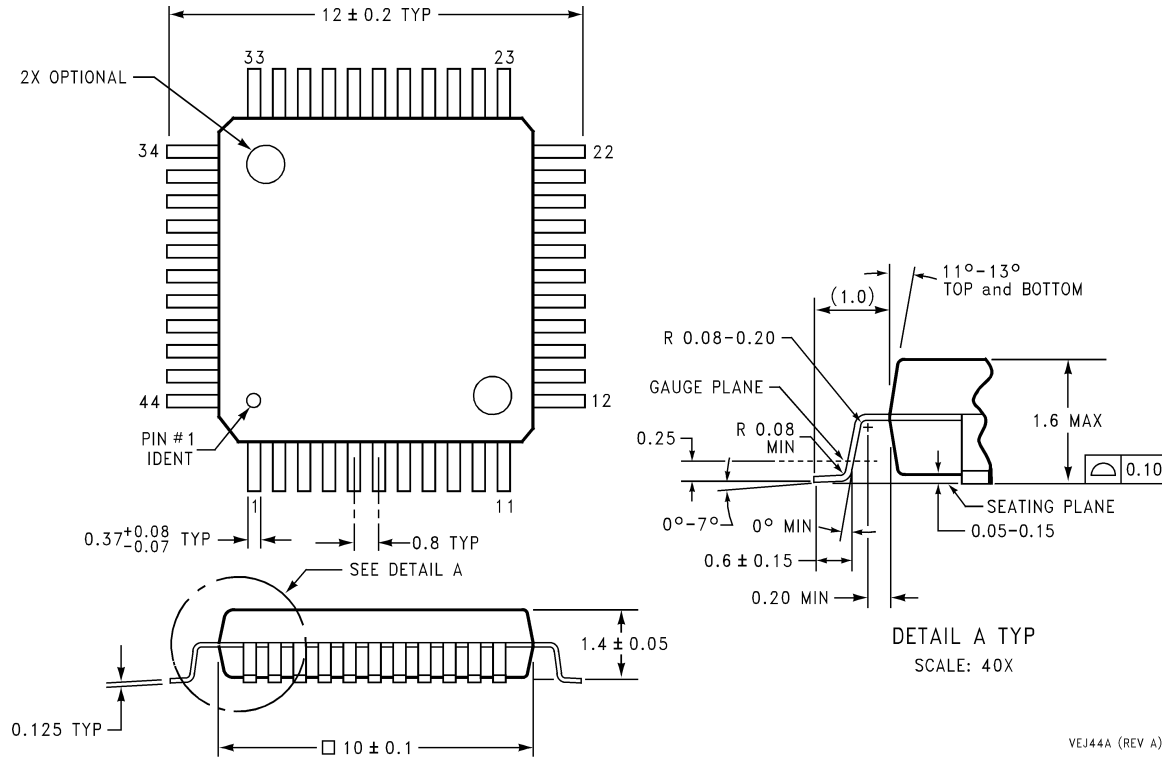
BEEP CIRCUITRY

The beep circuitry is designed to allow a "sleeping" system to temporarily power-up the LM4831 and output an audio alert ("beep"). This feature might be used in a computer which is "sleeping", but needs to notify the user that the computer batteries are low or that the user has new e-mail.

The beep circuitry is activated by any edge which occurs on the BEEP A-D pins. With a resistor, R_{beep} , and a capacitor, C_{beep} , in parallel at the RC pin of the LM4831, the LM4831 will be activated for $R_{\text{beep}} C_{\text{beep}}$ seconds. Typical values for R_{beep} and C_{beep} are $1\text{-}10\text{M}\Omega$ and $0.1\mu\text{F}$.

The BEEP OUT pin is designed to signal other audio circuitry that the LM4831 is powering up. Generally a CODEC will receive this signal and begin sending audio information to the LM4831. Logically, the BEEP OUT signal is the result of an XOR of the BEEP A-D pins.

Physical Dimensions inches (millimeters) unless otherwise noted



44-Lead Thin Quad Flat Package
Order Number LM4831VF
NS Package Number VEJ44A

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National Semiconductor Corporation
Americas
Tel: 1-800-272-9959
Fax: 1-800-737-7018
Email: support@nsc.com
www.national.com

National Semiconductor Europe
Fax: +49 (0) 180-530 85 86
Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 69 9508 6208
English Tel: +44 (0) 870 24 0 2171
Français Tel: +33 (0) 1 41 91 87 90

National Semiconductor Asia Pacific Customer Response Group
Tel: 65-2544466
Fax: 65-2504466
Email: ap.support@nsc.com

National Semiconductor Japan Ltd.
Tel: 81-3-5639-7560
Email: nsj.crc@jksmt.nsc.com
Fax: 81-3-5639-7507